

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
 Stylesheet Version v1.2

EPAS ID: PAT2671295

SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>YANGSYU LIN</td> <td>11/01/2013</td> </tr> <tr> <td>HSIAO WEN LU</td> <td>11/01/2013</td> </tr> <tr> <td>CHITING CHENG</td> <td>11/01/2013</td> </tr> <tr> <td>JONATHAN TSUNG-YUNG CHANG</td> <td>11/01/2013</td> </tr> </tbody> </table>		Name	Execution Date	YANGSYU LIN	11/01/2013	HSIAO WEN LU	11/01/2013	CHITING CHENG	11/01/2013	JONATHAN TSUNG-YUNG CHANG	11/01/2013		
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CORRESPONDENCE DATA													
Fax Number:	(215)689-4905												
Phone:	215-979-1000												
Email:	jsjiulianti@duanemorris.com												
<i>Correspondence will be sent via US Mail when the email attempt is unsuccessful.</i>													
Correspondent Name:	DUANE MORRIS LLP (TSMC) IP DEPARTMENT												
Address Line 1:	30 SOUTH 17TH STREET												
Address Line 4:	PHILADELPHIA, PENNSYLVANIA 19103-4196												
ATTORNEY DOCKET NUMBER:	2013.1445/1085.01338												
NAME OF SUBMITTER:	DAVID T. XUE												

Signature:	/David T. Xue/
Date:	01/08/2014
Total Attachments: 3 source=ExecutedAssign#page1.tif source=ExecutedAssign#page2.tif source=ExecutedAssign#page3.tif	

ASSIGNMENT AND AGREEMENT

For value received, we, Yangsyu LIN, Hsiao Wen LU, Chiting CHENG, and Jonathan Tsung-Yung CHANG, hereby transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Hsinchu Science Park, Hsin-Chu 300-77, Taiwan, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to **HIGH DENSITY MEMORY STRUCTURE**, described in non-provisional patent application S.N. 14/068,003, filed **October 31, 2103**, and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof, or claiming priority therefrom that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

We authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from us, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

We hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

We request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

We agree that, when requested, we shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Inventor No. 1

Dated: 2013.11.1

Yangsyu Lin
Yangsyu LIN

Residence:

8F., No. 23, Lane 311, Min-an Road, Xinzhuang District, New Taipei City 242, Taiwan, R.O.C.

Inventor No. 2

Dated: 2013.11.1

Hsiao Wen Lu
Hsiao Wen LU

Residence:

No. 4, Guoyuan 5th Street, Guishan Township, Taoyuan County 333, Taiwan, R.O.C.

Inventor No. 3

Dated: 2013.11.1

Chiting Chen
Chiting CHEN

Residence:

No. 54, Lane 89, Section 3, Taichung Port Road, Xitun District, Taichung City 407, Taiwan, R.O.C.

ATTORNEY DOCKET NO.: 2013.1445/1085.01338

Inventor No. 4

Dated: 11/1/2013


Jonathan Tsung-Yung CHANG

Residence:

14F., No. 178, Guanxin East Road, East District, Hsinchu City 300, Taiwan, R.O.C.